LOW CAPACITANCE TVS ARRAY



DESCRIPTION

The PESD12ULC is a low capacitance TVS array that is designed to protect components from damage or upset due to electrostatic discharge (ESD). The device is offered in a unidirectional configuration and is available in two lead DFN-0603 package. The PESD12ULC features a large cross sectional area junction for conducting high transient currents, fast response time and low operating voltage. This device meets the IEC 61000-4-2 and IEC 61000-4 requirements.

FEATURES

- Compatible with IEC 61000-4-2 (ESD): Air ±30kV, Contact ±30kV
- Compatible with IEC 61000-4-4 (EFT): 40A, 5/50ns
- 70 Watts Peak Pulse Power per Line (tp = 8/20μs)
- Unidirectional Configuration
- Protects 1 Data Line
- Low Clamping Voltage
- Easy Placement for Manufacturing
- Replacement for MLV (0402)
- Fast Response Time: < 1ns
- RoHS Compliant
- REACH Compliant

MECHANICAL CHARACTERISTICS

- Molded DFN-0603-2L Package
- Approximate Weight: 0.8 milligrams
- Lead-Free Plating: 100% Matte Sn(Tin)
- Solder Reflow Temperature 260-270°C
- 8mm Tape and Reel Per EIA Standard 481
- Meets MSL 1 Requirements
- Flammability Rating UL 94V-0

APPLICATIONS

- Cellular Phones
- Portable Devices
- Digital Cameras
- Power Supplies

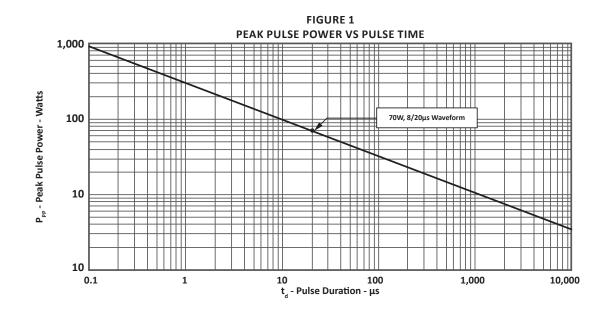
PIN CONFIGURATION



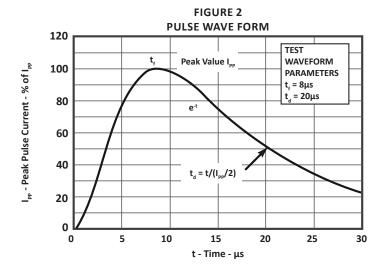
TYPICAL DEVICE CHARACTERISTICS

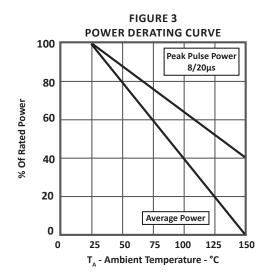
MAXIMUM RATINGS @ 25°C Unless Otherwise Specified							
PARAMETER SYMBOL VALUE UN							
Storage Temperature	T _{stg}	-55 to 150	°C				
Junction Temperature	T,	-55 to 150	°C				
Peak Pulse Power (tp = 8/20μs) - See Figure 1	P _{PP}	70	Watts				

ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified								
PART NUMBER	DEVICE MARKING	STAND-OFF BREAKDOWN CLAMPING CLAMPING LEAKAG VOLTAGE VOLTAGE (Fig. 2) (Fig. 2)	MAXIMUM LEAKAGE CURRENT	TYPICAL CAPACITANCE				
		V _{wm} VOLTS	@ 1mA V _(BR) VOLTS	@ IP = 2A V _c VOLTS	@ IP = 3.5A V _c VOLTS	@ 12V _D μΑ	@0V, 1MHz C pF	
PESD12ULC	М	12.0	14.5	20.5	23.0	1.0	15.5	

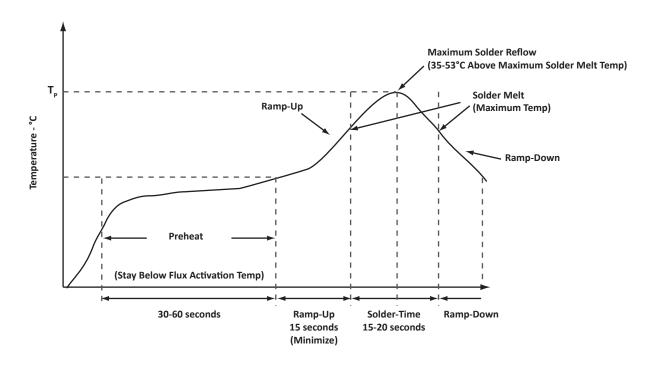


TYPICAL DEVICE CHARACTERISTICS





PACKAGE INFORMATION



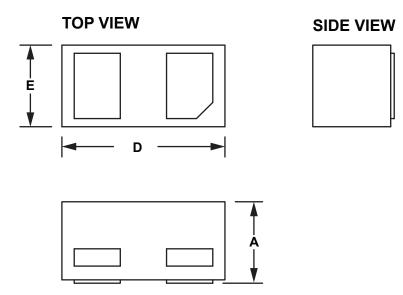


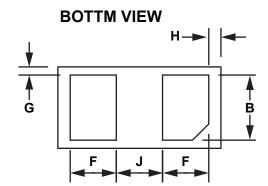
PACKAGE INFORMATION

OUTLINE DIMENSIONS							
DIM	MILLIN	IETERS	INCHES				
DIIVI	MIN	MAX	MIN	MAX			
А	0.290	0.325	0.011	0.013			
В	0.210	0.270	0.007	0.011			
D	0.570	0.630	0.022	0.025			
Е	0.270	0.330	0.011	0.014			
F	0.140	0.200	0.006	0.008			
G	0.015	0.045	0.0005	0.002			
Н	0.030	0.060	0.001	0.003			
J	0.140	0.200	0.006	0.008			

NOTES

- 1. Dimensioning and tolerances per ANSI Y14.M, 1985.
- 2. Controlling dimension: inches.

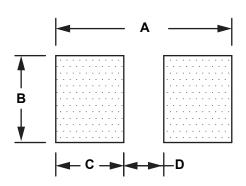




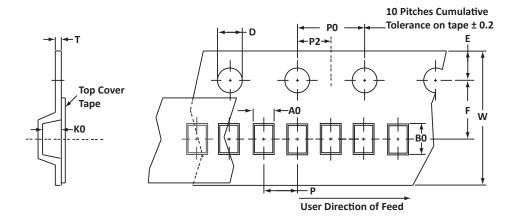
PAD LAYOUT DIMENSIONS						
DINA	MILLIMETERS	INCHES				
DIM	NOM	NOM				
А	0.650	0.025				
В	0.320	0.013				
С	0.250	0.010				
D	0.150	0.006				

NOTES

1. Decimal tolerances for mounting pad: ±0.003" (±0.08 mm).



TAPE AND REEL



SPECIFICATIONS												
REEL DIA.	TAPE WIDTH	A0	В0	ко	D	E	F	w	P0	P2	Р	tmax
178mm (7")	8mm	TBD	TBD	TBD	1.55 ± 0.10	1.75 ± 0.10	3.50 ± 0.05	8.00 ± 0.30	4.00 ± 0.10	2.00 ± 0.05	2.00 ± 0.05	0.25

NOTES

- 1. Dimensions are in millimeters.
- 2. Surface mount product is taped and reeled in accordance with EIA-481.
- 3. Suffix T710 = 7" Reel 10,000 pieces per 8mm tape.
- 4. Marking on Part marking code (see page 2).

ORDERING INFORMATION							
BASE PART NUMBER LEADFREE SUFFIX TAPE SUFFIX QTY/REEL REEL SIZE TUI							
PESD12ULC	PESD12ULC N/A -T710			7"	N/A		
This device is only available in a Lead-Free configuration.							

COMPANY INFORMATION

COMPANY PROFILE

In business more than 25 years, ProTek Devices™ is a privately held semiconductor company. The company offers a product line of overvoltage protection and overcurrent protection components. These include transient voltage suppressor array (TVS arrays) avalanche breakdown diode, steering diode TVS array and electronics SMD chip fuses. These components deliver circuit protection in electronic systems from numerous overvoltage and overcurrent events. They include lightning; electrostatic discharge (ESD); nuclear electromagnetic pulses (NEMP); inductive switching; and electromagnetic interference (EMI) / radio frequency interference (RFI). ProTek Devices also offers LED wafer die for ESD protection and related high frequency products. ProTek Devices is ISO 9001:2015 certified.

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